

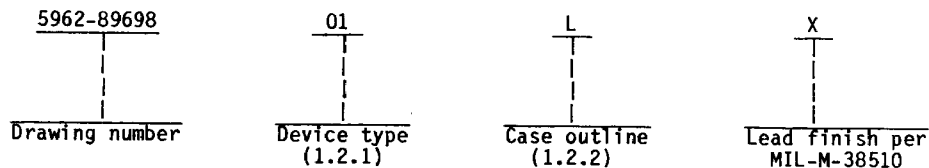
* U.S. GOVERNMENT PRINTING OFFICE: 1987 — 748-129/60911
5962-E1442

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	AD7579	10-bit ADC with an (8+2) read interfacing structure
02	AD7580	10-bit ADC with a 10-bit parallel word

1.2.2 Case outline. The case outline shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
L	D-9 (24-lead, 1.280" x .310" x .200"), dual-in-line package

1.3 Absolute maximum ratings.

V _{DD} to AGND, DGND	- - - - -	-0.3 V dc to +7.0 V dc
AGND to DGND	- - - - -	-0.3 V dc to V _{DD}
Digital input voltage to DGND	- - - - -	-0.3 V dc to V _{DD} + 0.3 V dc
Digital output voltage to DGND	- - - - -	-0.3 V dc to V _{DD} + 0.3 V dc
CLK input voltage to DGND	- - - - -	-0.3 V dc to V _{DD} + 0.3 V dc
V _{REF} to AGND	- - - - -	-0.3 V dc to V _{DD}
V _{IN} (*)A, V _{IN} (*)B to AGND (see figure 1)	- - - - -	-0.3 V dc to V _{DD} + 0.3 V dc
V _{IN} (*)A to AGND (see figure 2)	- - - - -	-0.6 V dc to 2V _{DD} + 0.6 V dc
V _{IN} (*)A to AGND (see figure 3)	- - - - -	V _{DD} - 0.3 V dc to V _{DD} + 0.3 V dc
Storage temperature range	- - - - -	-65°C to +150°C
Lead temperature (soldering, 10 seconds)	- - - - -	+300°C
Power dissipation at T _A < 75°C (P _D) 1/	- - - - -	450 mW
Thermal resistance, junction-to-case (θ _{JC})	- - - - -	See MIL-M-38510, appendix C
Junction temperature (T _J)	- - - - -	+175°C

1/ Derate above T_A = +75°C at 6.0 mW/°C.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 2

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547

1.4 Recommended operating conditions.

Supply voltage range (V_{DD}) - - - - - +4.75 V dc to +5.25 V dc
 Reference voltage (V_{REF}) - - - - - +2.5 V
 Analog and digital ground voltage (AGND and DGND) - - - - - 0 V
 Clock frequency (f_{CLK}) - - - - - 2.5 MHz

Analog input range (see figure 1):

Span - - - - - V_{REF}
 Common mode range - - - - - 0 V to V_{DD}

Analog input range (see figure 2):

Span - - - - - $2V_{REF}$
 Common mode range - - - - - 0 V to $2V_{DD}$

Analog input range (see figure 3):

Span - - - - - $2V_{REF}$
 Common mode range - - - - - $-V_{REF}$ to $(2V_{DD} - V_{REF})$

Ambient operating temperature range (T_A) - - - - - -55°C to $+125^{\circ}\text{C}$

2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103 - List of Standardized Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 3

DESC FORM 193A
 SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988 - 549-904

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 4.

3.2.2 Truth tables. The truth tables shall be as specified on figure 5.

3.2.3 Case outline. The case outline shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see 6.6 herein).

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.9 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 4

DESC FORM 193A
SEP 87

☆ U. S. GOVERNMENT PRINTING OFFICE: 1988 - 549-904

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ -55°C < T _A < +125°C unless otherwise specified	Device types	Group A subgroups	Limits		Unit
					Min	Max	
Integral nonlinearity <u>2/</u>	INL		A11	1,2,3		±1.0	LSB
Differential nonlinearity <u>2/</u>	DNL	No missing codes guaranteed over the full temperature range	A11	1,2,3		±0.9	LSB
Full scale error <u>2/</u>	AE		A11	1,2,3		±5.0	LSB
Zero code error <u>2/ 3/</u>	AZCE	Connected as on figure 1	A11	1,2,3		±3.0	LSB
		Connected as on figure 2	A11			±3.0	
Power supply rejection <u>4/</u>	PSR	4.75 V < V _{DD} < 5.25 V	A11	1,2,3		±0.5	LSB
Power supply current	I _{DD}	V _{DD} = +5.0 V	A11	1,2,3		10	mA
Attenuator input resistance <u>5/</u>	R _{IN(AT)}		A11	1,2,3	5.0	15	MΩ
Comparator input resistance	R _{IN} (comp)	Connected as on figure 1	A11	1,2,3	10		MΩ
Reference input current	I _{REF}		A11	1,2,3		1.5	mA
Digital input low voltage	V _{INL}	\overline{CS} , \overline{RD} , \overline{WR} , HBEN and CLK HBEN, device 01 only	A11	1,2,3		0.8	V
Digital input high voltage	V _{INH}				2.4		
Digital input current	I _{IN}	\overline{CS} , \overline{RD} , \overline{WR} , HBEN, and CLK, V _{IN} = 0 V to V _{DD} HBEN, device 01 only	A11	1		±1.0	μA
				2,3		±10	

See footnotes at end of table.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A	5962-89698	
		REVISION LEVEL	SHEET 5

DESC FORM 193A
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

TABLE 1. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 1/ -55°C < T _A < +125°C unless otherwise specified	Device types	Group A subgroups	Limits		Unit
					Min	Max	
Input capacitance <u>6/</u>	C _{IN}	CS, RD, WR, HBEN, and CLK see 4.3.1b, T _A = +25°C HBEN, device 01 only.	A11	4		10	pF
Digital output low voltage	V _{OL}	DB0 to DB7, I _{SINK} = 1.6 mA	A11	1,2,3		0.4	V
Digital output high voltage	V _{OH}	DB0 to DB7, I _{SOURCE} = 400 μA	A11	1,2,3	4.0		V
Floating state leakage current	I _{LG}	DB0 - DB7, V _{OUT} = 0 to V _{DD}	A11	1,2,3		±10	μA
Floating state output capacitance <u>6/</u>	C _{OUT}	DB0 - DB7, see 4.3.1b T _A = +25°C	A11	4		10	pF
Output low voltage	V _{OL}	RDY, INT, I _{SINK} = 1.6 mA	A11	1,2,3		0.4	V
Conversion time <u>7/</u>	T _{CONV}	f _{CLK} = 2.5 MHz, t _{WR} = 100 μs	A11	1,2,3	16.9	18.5	μs
Sampling rate <u>7/</u>	t _{SAMP}		A11	7,8		50	kHz
Functional test		See 4.3.1c	A11	7,8			
Signal-to-noise ratio <u>6/</u> <u>7/</u>	SNR		A11	4,5,6	55		dB
CS to WR setup time <u>6/</u>	t ₁	See figure 6 <u>8/</u>	A11	9,10,11	0		ns
WR pulse width	t ₂			9	40		ns
				10,11	50		
CS to WR hold time <u>6/</u>	t ₃			9,10,11	0		ns
WR to INT propagation delay time <u>6/</u>	t ₄	See figures 6, 8, and 9 <u>9/</u>	A11	9		100	ns
				10,11		120	

See footnotes at end of table.

**STANDARDIZED
MILITARY DRAWING**

 DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

 SIZE
A

5962-89698

REVISION LEVEL

SHEET

6

 DESC FORM 193A
SEP 87

© U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 1/ -55°C < T _A < +125°C unless otherwise specified	Device types	Group A subgroups	Limits		Unit
					Min	Max	
\overline{CS} to \overline{RD} setup time 6/	t ₅	See figure 7 8/	A11	9,10,11	0		ns
\overline{RD} pulse width 6/	t ₆		A11	9,10,11	t ₁₂		ns
\overline{CS} to \overline{RD} hold time 6/	t ₇		A11	9,10,11	0		ns
HBEN to \overline{RD} setup time	t ₈		01	9	20		ns
				10,11	30		
HBEN to \overline{RD} hold time	t ₉		01	9,10,11	10		ns
RDY access time 6/	t ₁₀	See figures 7, 8, and 9 9/	A11	9	110		ns
				10,11	150		
\overline{RD} to INT propagation delay time 6/	t ₁₁		A11	9		100	ns
				10,11		120	
Data access time after \overline{RD}	t ₁₂		A11	9		110	ns
				10,11		150	
Data hold time, RDY hold time	t ₁₃	See figures 7 and 10 6/ 10/	A11	9	10	65	ns
				10,11	10	90	

1/ V_{DD} = +5.0 V ±5.0%, V_{REF} = +2.5 V, AGND = DGND = 0 V, f_{CLK} = 2.5 MHz, and connected as shown on figure 1, unless otherwise specified.

2/ Specification applies for the three Analog Input Ranges: 0 to V_{DD}, 0 to 2V_{DD}, -V_{REF} to (2V_{DD} - V_{REF}). INL tested using figure 1, DNL tested using figure 2, configuration B.

3/ Zero code error is measured with respect to an ideal first code transition which occurs at 0.5 LSB.

4/ Power supply rejection is tested for full scale error only.

5/ Resistance is measured between V_{IN}(+)A, V_{IN}(+)B or V_{IN}(-)A, V_{IN}(-)B.

6/ Measured only for the initial test and after any process or design changes which may affect these parameters.

7/ These specifications apply for full scale input signals up to 20 kHz.

8/ All input control signals are specified with t_r = t_f = 20 ns (10 percent to 90 percent of +5.0 V) and timed from a voltage level of +1.6 V.

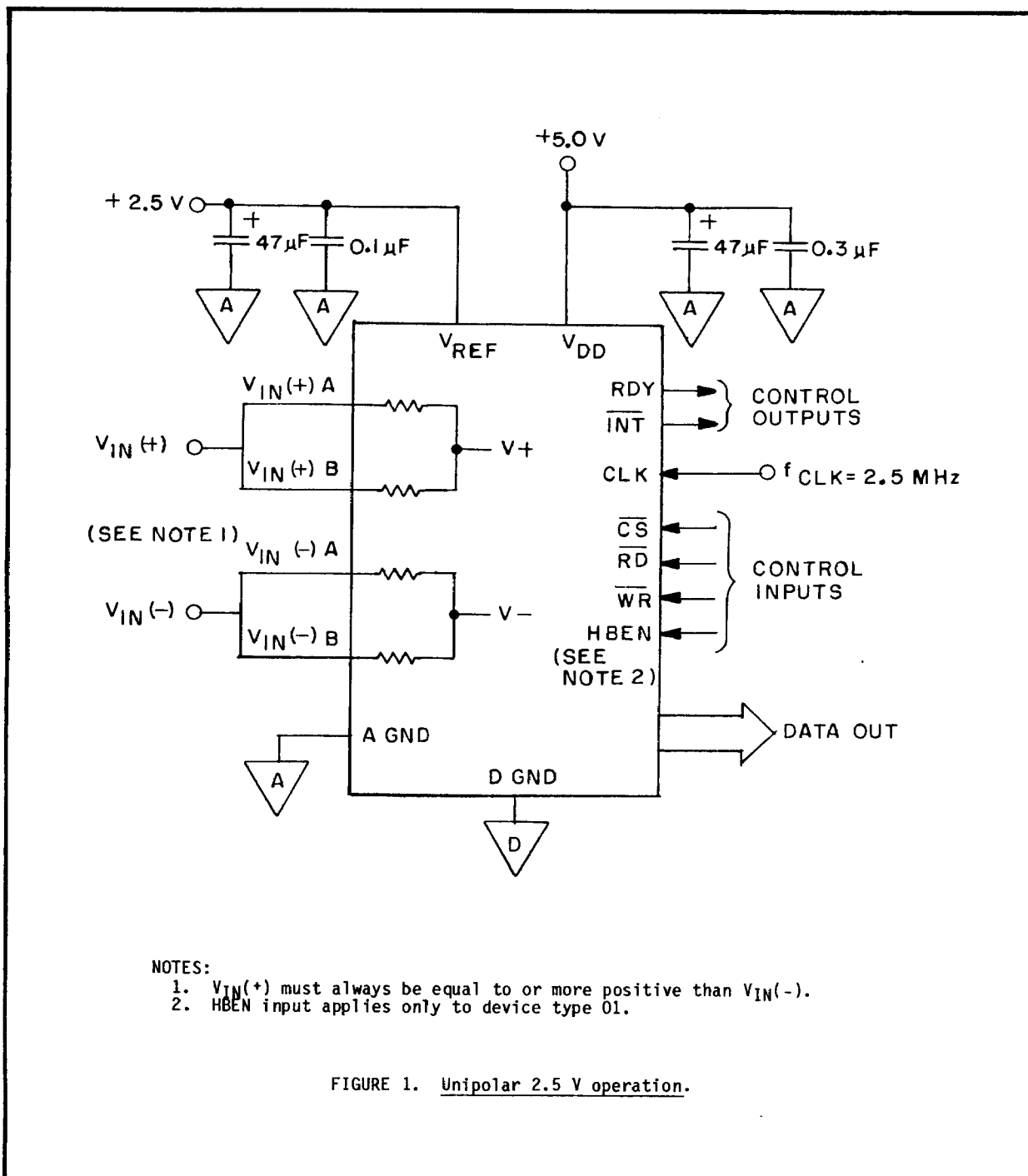
9/ t₄, t₁₀, t₁₁ and t₁₂ are measured with the load circuits of figures 8 and 9 and defined as the time required for an output to cross 0.8 V or 2.4 V.

10/ t₁₃ is defined as the time required for the data lines to change 0.5 V when loaded with the circuits of figure 10.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 7

DESC FORM 193A
SEP 87

☆ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904



NOTES:

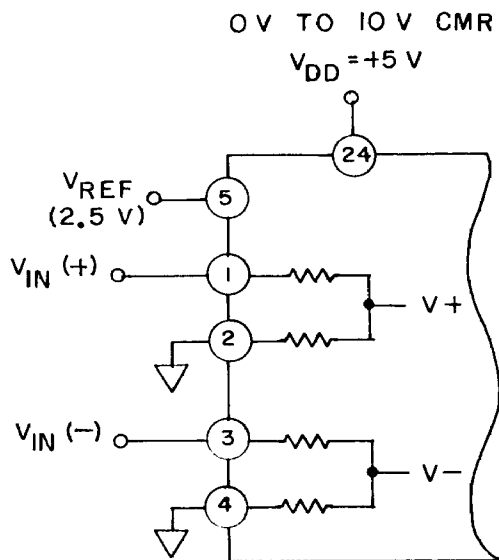
1. $V_{IN}(+)$ must always be equal to or more positive than $V_{IN}(-)$.
2. HBEN input applies only to device type 01.

FIGURE 1. Unipolar 2.5 V operation.

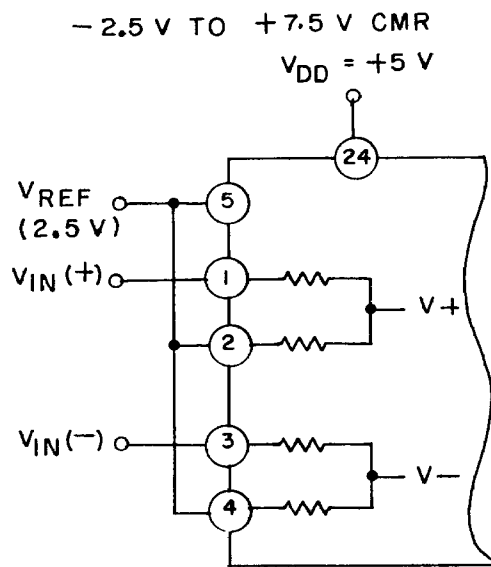
STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 8

DESC FORM 193A
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547



CONFIGURATION A



CONFIGURATION B

NOTES:

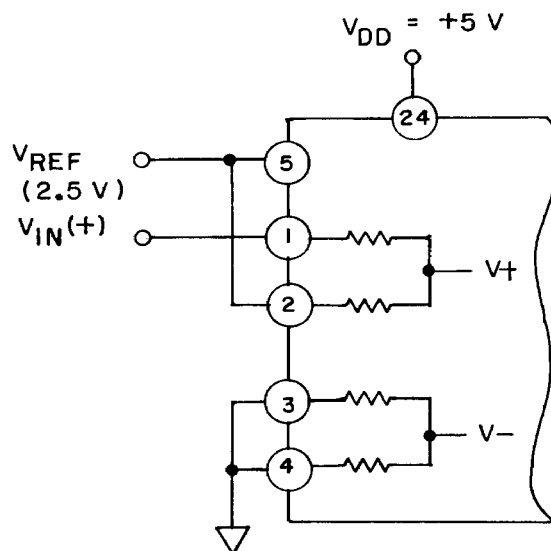
1. $V_{IN}(+)$ must always be equal to or more positive than $V_{IN}(-)$.
2. Decoupling and control circuitry are shown on figure 1.

FIGURE 2. 5.0 V span operation.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 9

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547



NOTES:

1. $V_{IN}(+)$ must always be equal to or more positive than $V_{IN}(-)$.
2. Decoupling and control circuitry are as shown on figure 1.

FIGURE 3. Single ended bipolar operation, -2.5 V to +2.5 V.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 10

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988 550 147

Device types	01	02
Case outline	L	
Terminal number	Terminal symbol	
1	$V_{IN}(+)A$	$V_{IN}(+)A$
2	$V_{IN}(+)B$	$V_{IN}(+)B$
3	$V_{IN}(-)A$	$V_{IN}(-)A$
4	$V_{IN}(-)B$	$V_{IN}(-)B$
5	V_{REF}	V_{REF}
6	$AGND$	$AGND$
7	CS	CS
8	WR	WR
9	RD	RD
10	INT see note	INT see note
11	CLK	CLK
12	DGND	DGND
13	HBEN	RDY see note
14	RDY see note	DB0(LSB)
15	DB0 (LSB)	DB1
16	DB1	DB2
17	DB2	DB3
18	DB3	DB4
19	DB4	DB5
20	DB5	DB6
21	DB6	DB7
22	DB7 (MSB)	DB8
23	I.C.	DB9 (MSB)
24	V_{DD}	V_{DD}

NOTES:

1. INT and RDY are open-drain outputs and need 3.0 k Ω external pull-up resistors for operation.
2. I.C. = internally connected.

FIGURE 4. Terminal connections.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 11

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

Device type 01

CS	WR	RD	HBEN	Function
1	X	X	X	Not selected
0	1	1	X	Selected, wait for WR, RD
0	T _T	1	X	Start conversion on falling edge of WR
0	1	0	0	Enable ADC data (8 LSB's), data is right justified
0	1	0	1	Enable ADC data (2 LSB's), data is right justified

Device type 02

CS	WR	RD	Function
1	X	X	Not selected
0	1	1	Selected, wait for WR, RD
0	T _T	1	Start conversion on falling edge WR
0	1	0	Enable ADC data (10 bits)

1 = high logic level

0 = low logic level

X = irrelevant

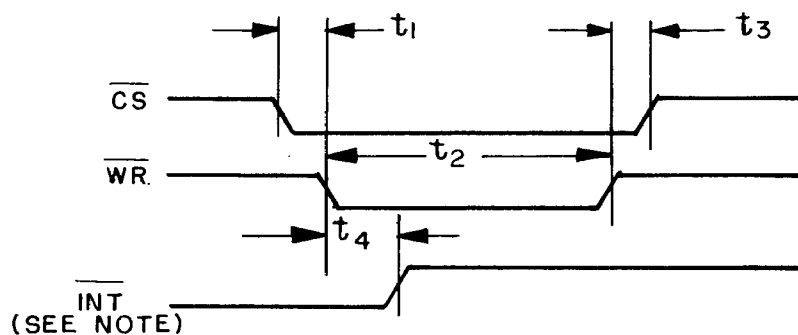
T_T = one clock cycle

FIGURE 5. Truth tables.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 12

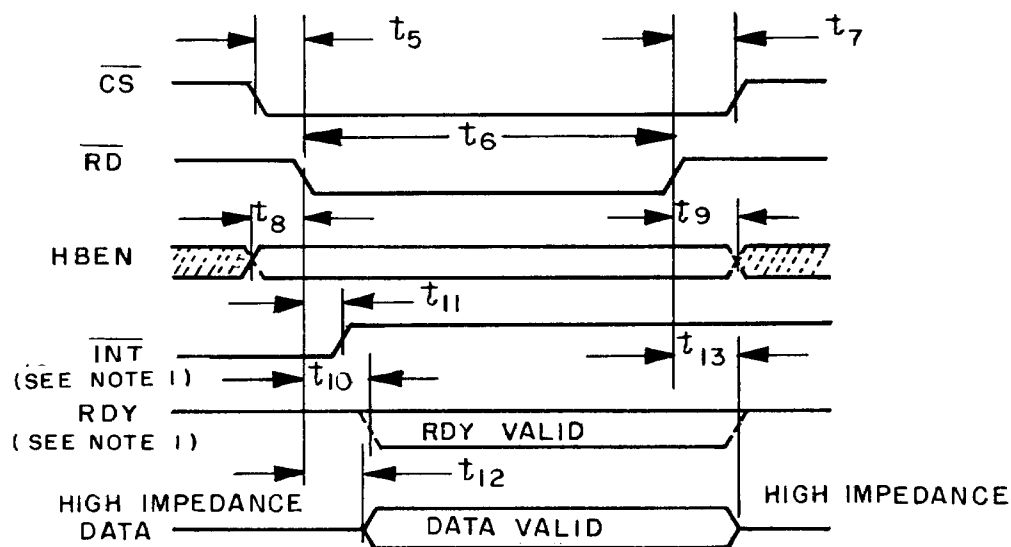
DESC FORM 193A
SEP 87

☆ U. S. GOVERNMENT PRINTING OFFICE: 1988 - 549 904



NOTE: INT has a 3.0 k Ω external pull-up resistor.

FIGURE 6. Start cycle timing diagram.



NOTES:

1. INT and RDY have 3.0 k Ω external pull-up resistors.
2. HBEN applies to device 01 only.

FIGURE 7. Read cycle timing diagram.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A	5962-89698	
		REVISION LEVEL	SHEET 13

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547

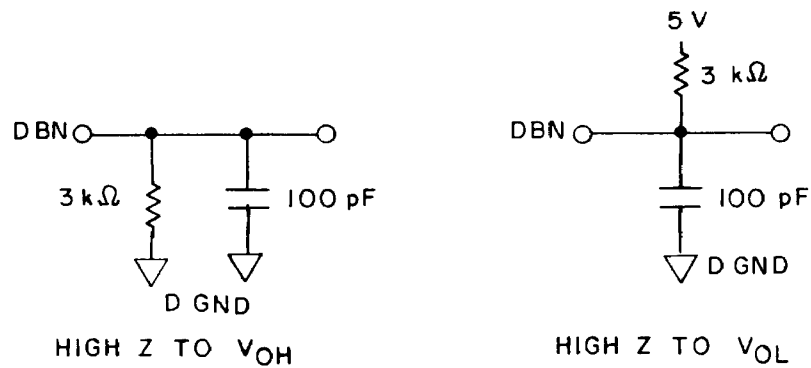


FIGURE 8. Load circuits for access time tests.

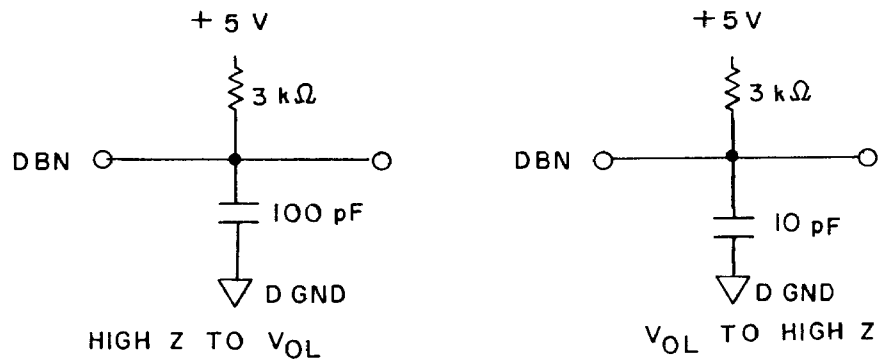


FIGURE 9. Load circuits for INT propagation delays.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A	5962-89698	
		REVISION LEVEL	SHEET 14

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547

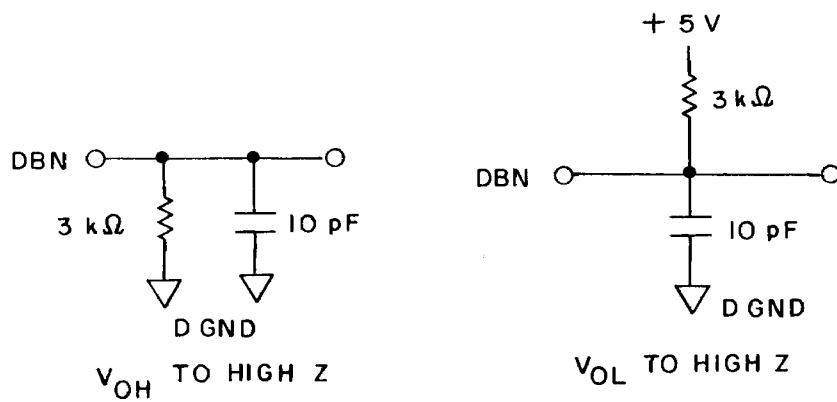


FIGURE 10. Load circuits for output float delay.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 15

DESC FORM 193A
SEP 87

☆ U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*,2,3,7,8
Group A test requirements (method 5005)	1,2,3,4,5,6,7, 8,9,10**,11**
Group C and D end-point electrical parameters (method 5005)	1

*PDA applies to subgroup 1.

**Subgroups 10 and 11, if not tested, shall be
guaranteed to the limits specified in table I.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 16

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988 549 904

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 shall be measured only for the initial test and after process or design changes which may affect the parameters specified in table I.
- c. Subgroup 7 and 8 shall include verification of the truth table.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).

6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECS, telephone (513) 296-6022.

6.5 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone (513) 296-5375.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 17

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

6.6 Approved source of supply. An approved source of supply is listed in MIL-BUL-103. Additional sources will be added to MIL-BUL-103 as they become available. The vendor listed in MIL-BUL-103 has agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECS. The approved source of supply listed below is for information purposes only and is current only to the date of the last action of this document.

Military drawing part number	Vendor CAGE number	Vendor similar part number 1/
5962-8969801LX	24355	AD7579SQ/883B
5962-8969802LX	24355	AD7580SQ/883B

1/ Caution. Do not use this number for item acquisition.
Items acquired to this number may not satisfy the
performance requirements of this drawing.

Vendor CAGE
number

24355

Vendor name
and address

Analog Devices
Route 1 Industrial Park
P.O. Box 9106
Norwood, MA 02062
Point of contact: 804 Woburn Street
Wilmington, MA 01887

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-89698
		REVISION LEVEL	SHEET 18

DESC FORM 193A
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1988-550-547

018242